

On Sintering Stress in Complex Powder Compacts

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Outline

- **What are we trying to model – simple solid-state sintering**
- **Which processes are we trying to model**



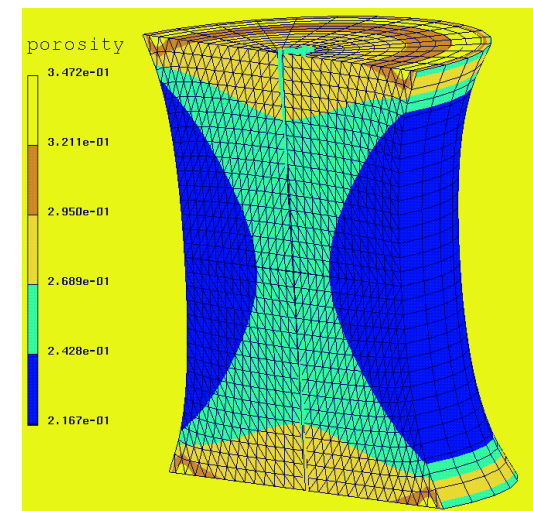
Objectives

- **Develop a mesoscale model to simulate microstructural evolution during solid-state sintering**
 - Understand microstructural evolution details
 - Obtain engineering sintering quantities
 - Sintering stress
 - Bulk and Shear viscosities
- **End goal: simulate constraint sintering with the accompanying shape distortion**
 - Variations in density
 - Multi-layered materials
 - Functionally graded materials
 - Powder packing defects



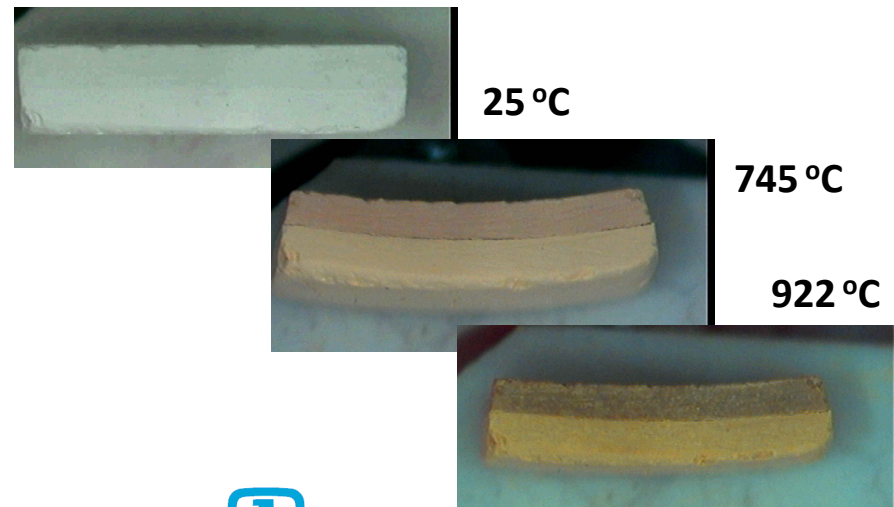
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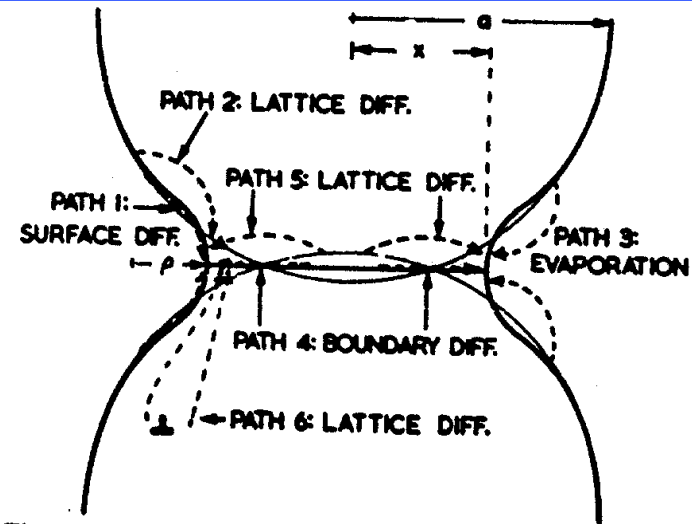
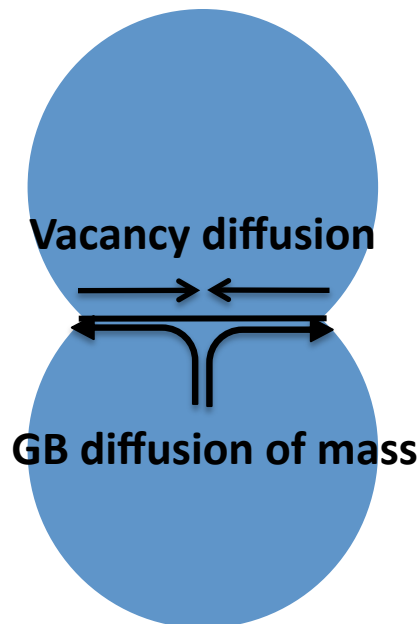
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During Simple Solid-State Sintering:

Mass transport described by
Classic Ashby model with the 6 paths

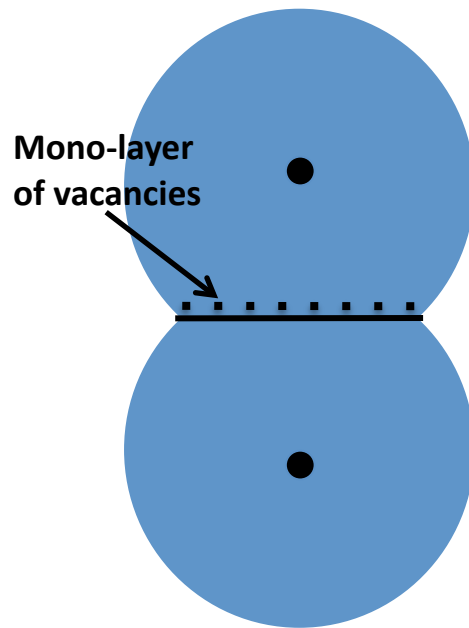
In this work:
grain boundary diffusion
surface diffusion
are active.



- Mass diffuses from the along the grain boundary to fill the pore
- Vacancies generated at the pore surface
- Vacancies diffuse from the pore to the grain boundary
- Vacancies are annihilated at the grain boundaries



Densification in Stereological Model of Sintering*



Densification

- Vacancies diffuse along the grain boundary
- They paint the grain boundary forming a mono-layer
- The entire monolayer is annihilated
- The centers of mass of the particles move closer
- The neck grows
- The pore shrinks

Densification Rate

• Rate of vacancy annihilations $\dot{n}_A = \frac{\int (-D_b \nabla C) \delta dL}{A_b}$

- As the neck area grows, the time between the annihilation events increases
- $\tau \approx A_b$

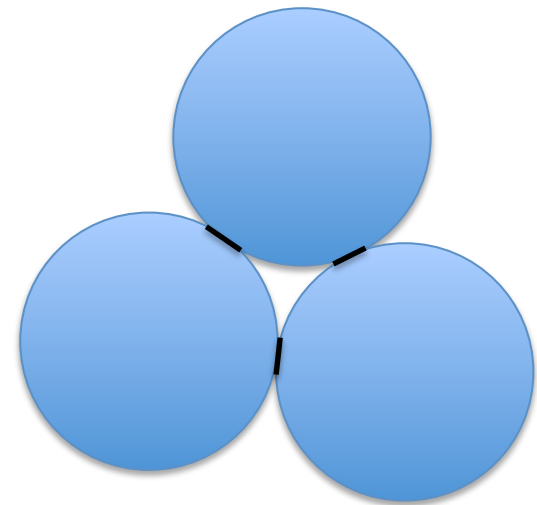
*R.T DeHoff, Sci. of Sintering, 1989



Surface Diffusion at Pore Surfaces in Stereological Model of Sintering*

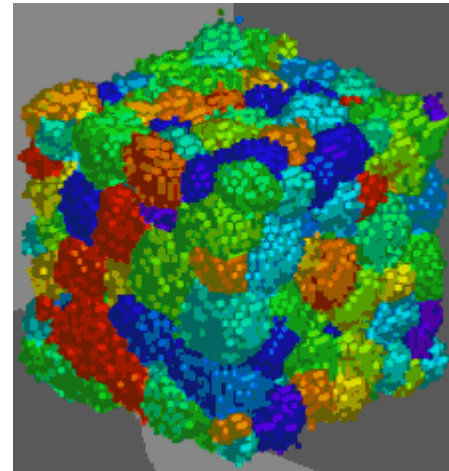
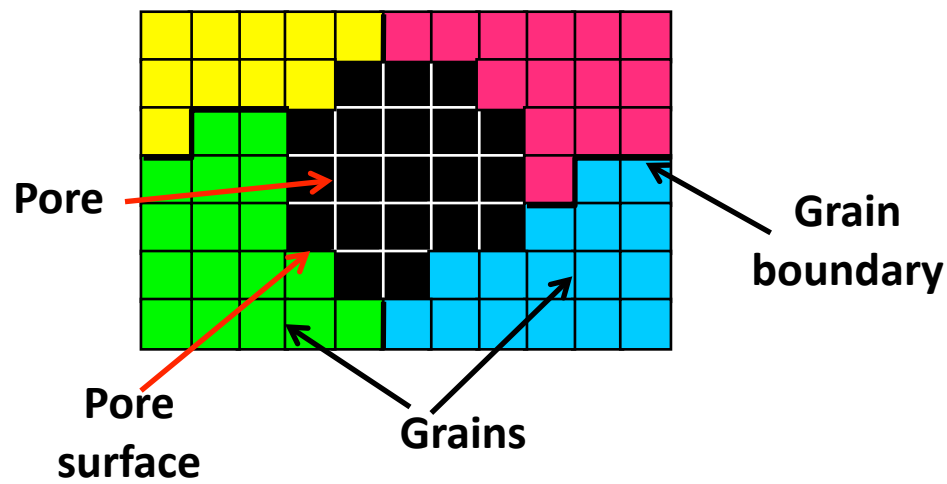
- Pores continually reshape themselves to lower their surface free energy
- Material is transported from areas of high curvature to lower curvature
- Velocity of pore surface

$$v_s = -\Omega \delta \nabla \cdot J_s$$



Potts kMC Model

- Microstructure is represented by digitizing on a cubic lattice:



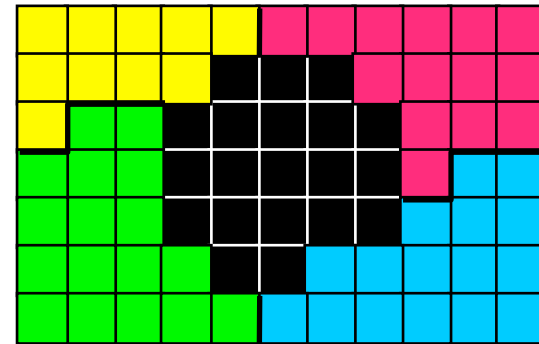
- Each voxel is a unit of matter



Potts kMC Model Equation of State

- Driving force for sintering is the reduction in total interfacial energy

$$E = \frac{1}{2} \sum_{i=1}^N \sum_{j=1}^{26} J_{ij} \left(1 - \delta(q_i, q_j) \right)$$



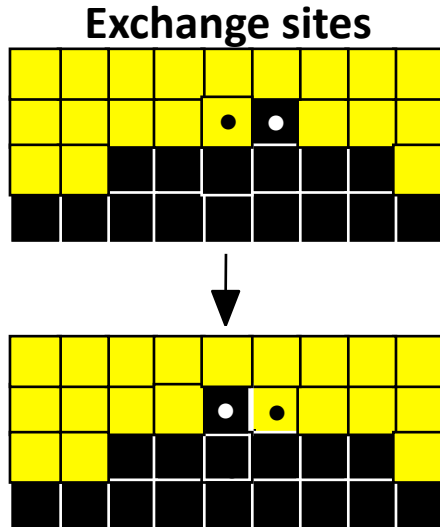
- Dihedral angle can be changed by adjusting J_{ij}



Potts kMC Model

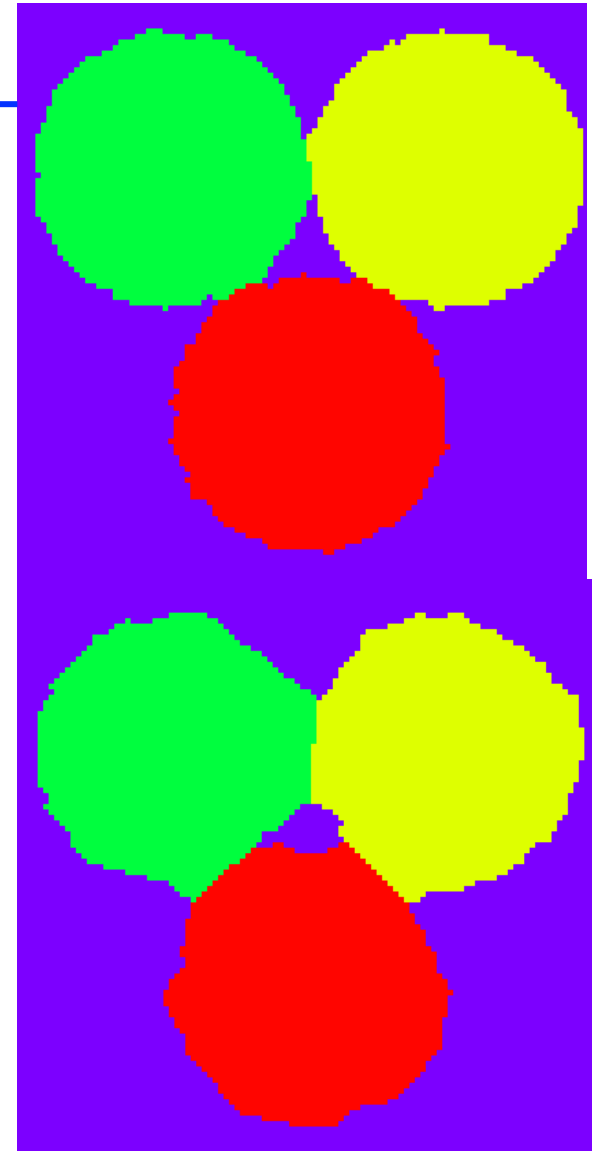
Pore Surface Diffusion

- Pore sites and grain sites at pore surface exchange places to simulate surface diffusion
- Minimize surface energy by Metropolis algorithm
- Calculate ΔE
- Probability of exchange is



$$P = 1 \quad \Delta E \leq 0$$

$$P = \exp\left(\frac{-\Delta E}{k_B T}\right) \quad \Delta E > 0$$



Potts kMC Model

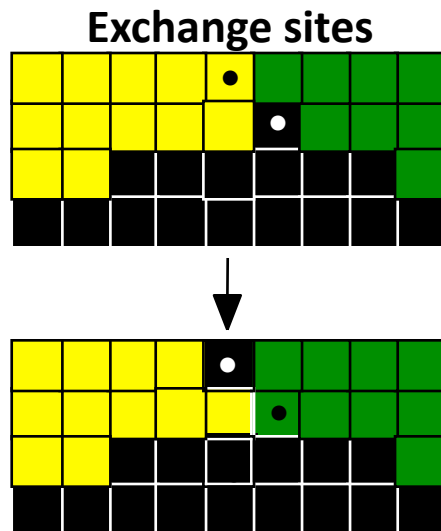
Vacancy Generation

- Vacancies are generated by the exchange mechanisms as shown.

- There is an equilibrium concentration of vacancies $P = \exp\left(\frac{-\Delta E}{k_B T}\right) \quad \Delta E > 0$

- Concentration of vacancies is proportional to the surface curvature

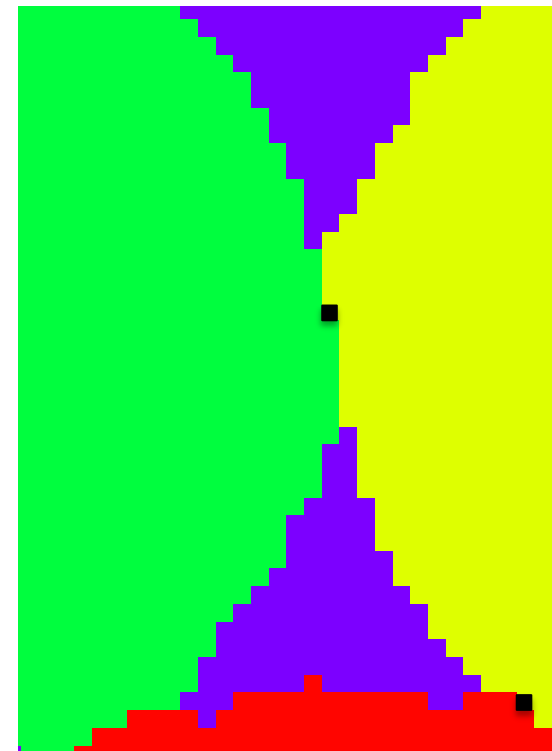
$$C_v \propto \frac{\gamma}{r}$$



Potts kMC Model

Vacancy Diffusion and Annihilation

- Stereological model
 - Paint a layer of vacancies on the neck and annihilate them.
 - Centroids of grains move closer to give densification.
- Potts model
 - Annihilation mono-layer is not possible.
 - Annihilate one vacancy with equal probability of being anywhere in the neck.
 - Annihilation frequency is $\tau \approx A_b$.
 - Annihilation is simulated by collapsing a column of sites.
 - Centroid of grains approach each other.
 - Powder compact densifies.

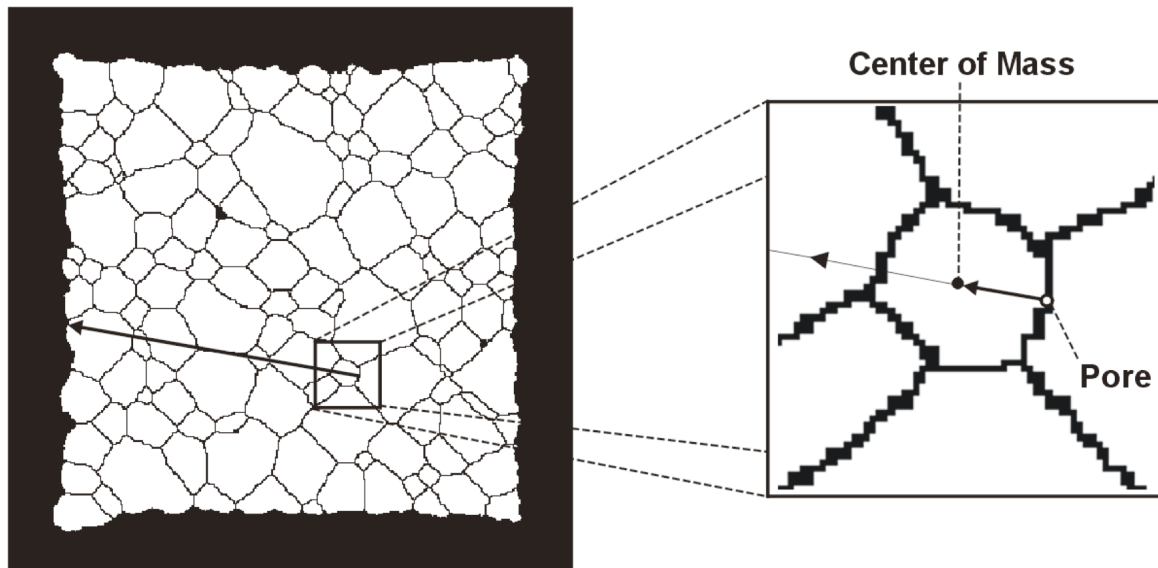


Potts kMC Model

Simulation of Annihilation

Annihilation of a vacancy on a grain boundary

- Draw a line from the vacancy through the COM to the external surface of the powder compact
- Collapse all the sites along the line by one pixel to fill the vacancy



Potts kMC Model

Grain Growth

Coarsening of grains during sintering

- Is a significant contributor
- Effects densification and distortions

Curvature-driven grain growth is simulated by grain boundary motion

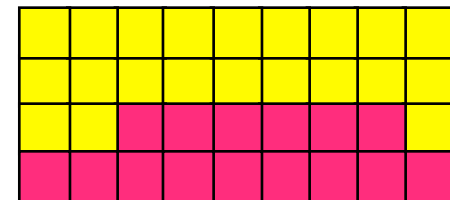
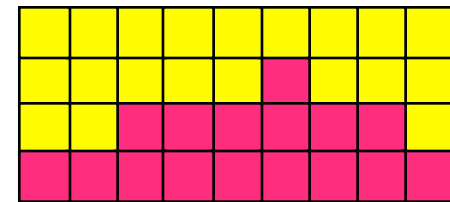
- Grain sites can change from one grain to another

- Calculate ΔE
$$E = \frac{1}{2} \sum_{i=1}^N \sum_{j=1}^{26} J_{ij} (1 - \delta(q_i, q_j))$$

- Probability of change
$$P = 1 \quad \Delta E \leq 0$$

$$P = \exp\left(\frac{-\Delta E}{k_B T}\right) \quad \Delta E > 0$$

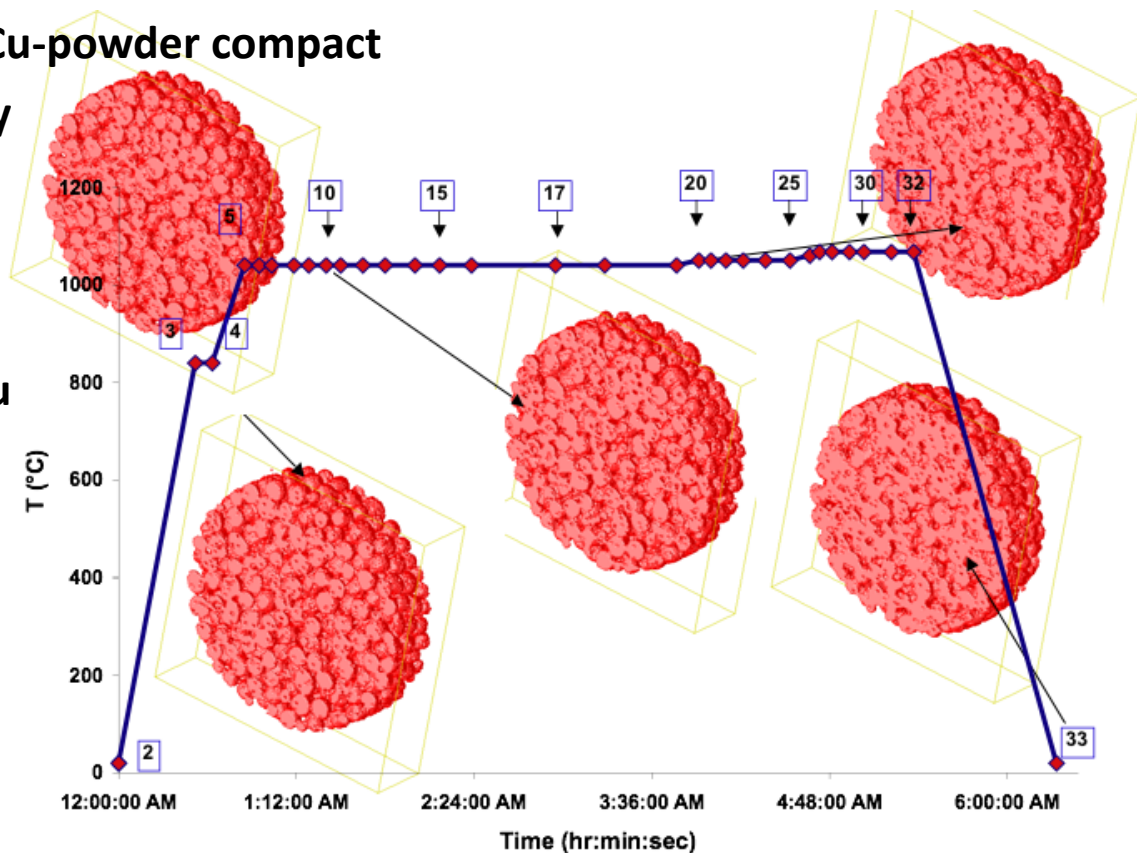
grain growth
change pixel color



Application and Validation of Potts kMC Sintering Model

Potts kMC Sintering model was tested by simulating

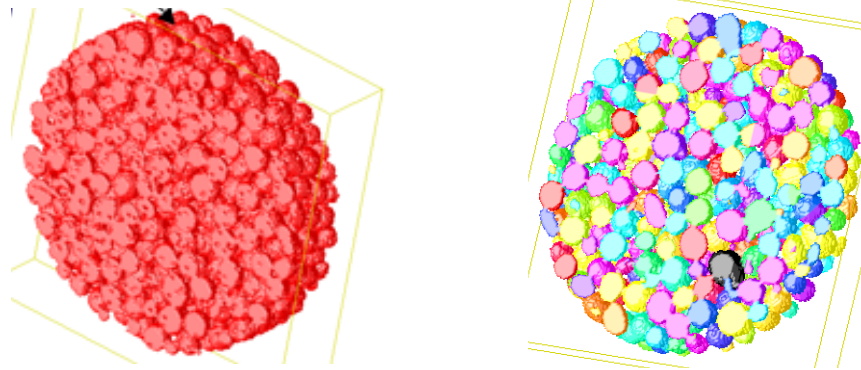
- Many simple geometries with analytic results.
- Comparing to sintering Cu-powder compact
- Imaged with high-energy X-rays in synchrotron
- Cu-particles 30 – 50 μm
- Shows the mass and pore distribution in-situ



Validation by Comparing to Cu-Compact Sintering Potts kMC Sintering Model

Grain structure extrapolated into the initial 3D image obtained from the synchrotron

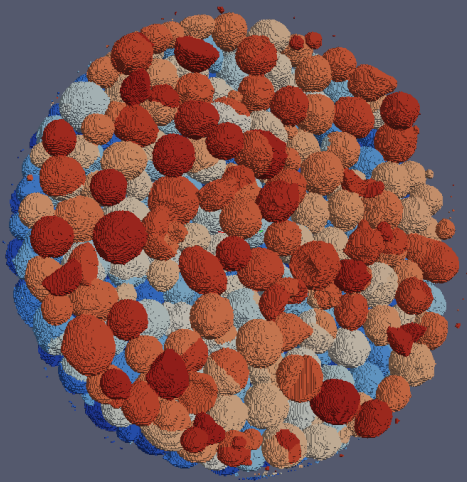
- Using the Potts grain growth algorithm



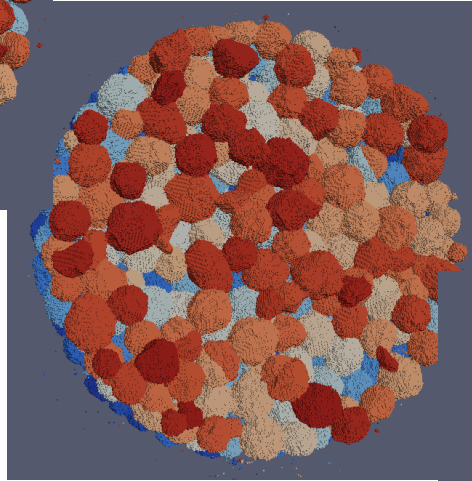
- Microstructural evolution during sintering from this image was compared to later experimentally obtained images.



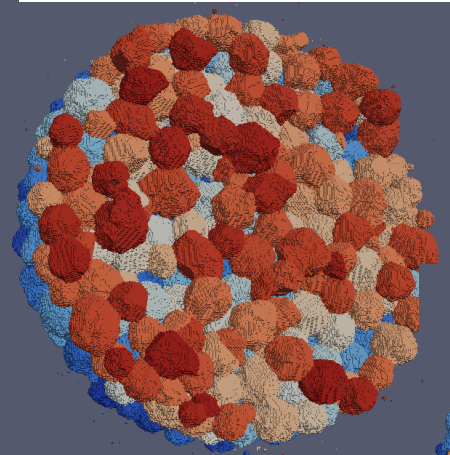
Potts kMC Model Simulation of Cu-Particles Compact



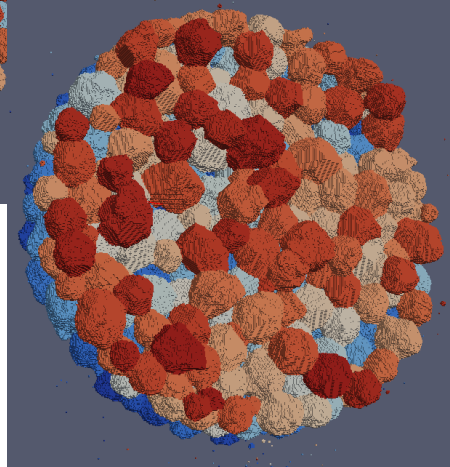
$\rho = 72\%$



$\rho = 82\%$



$\rho = 85\%$

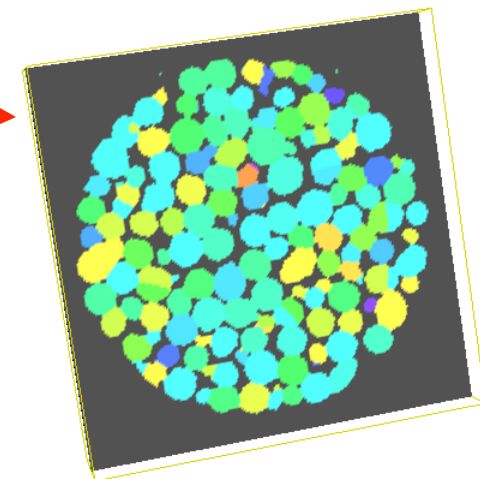
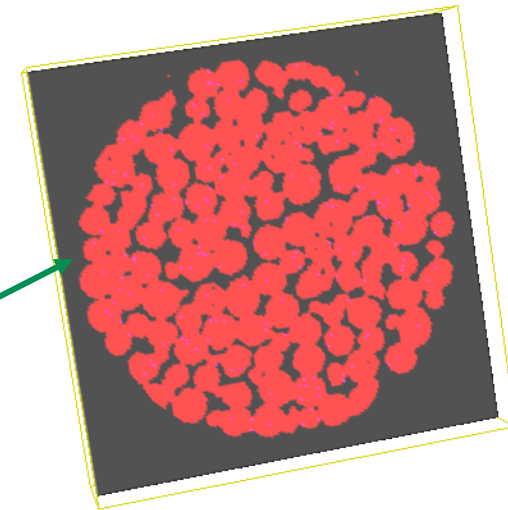
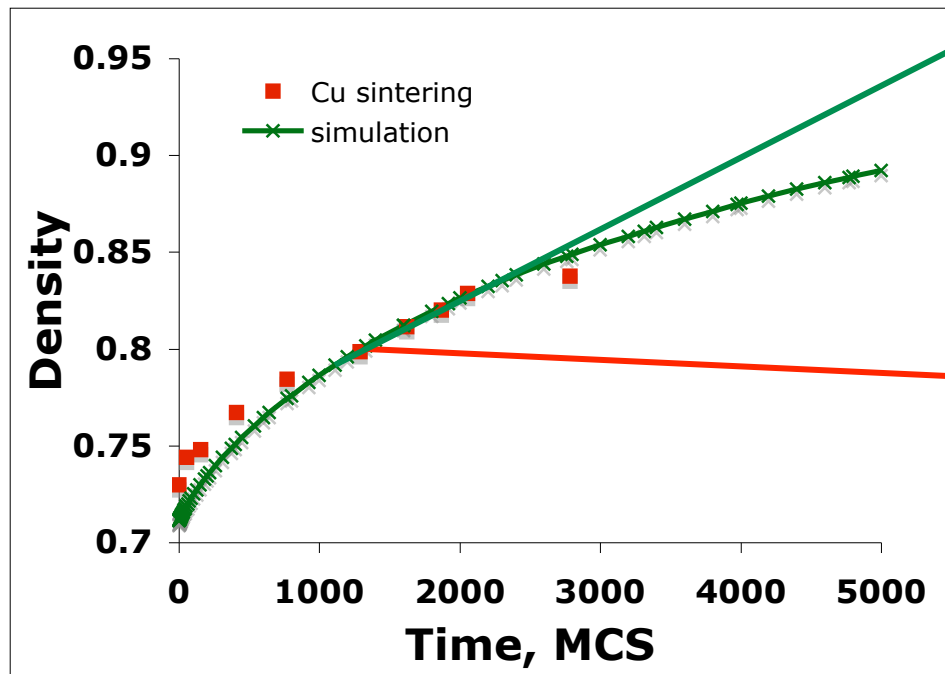


$\rho = 87\%$

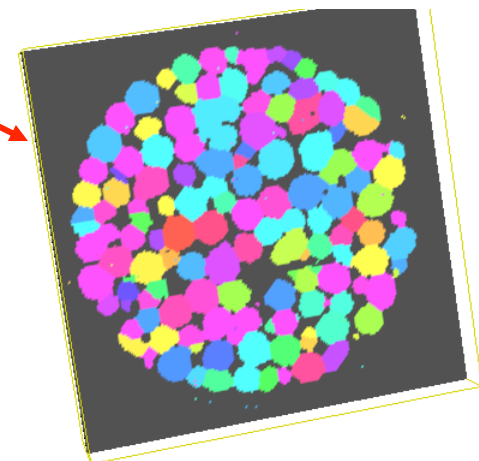
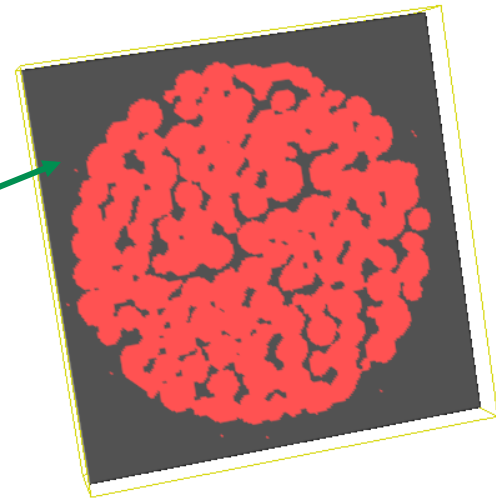
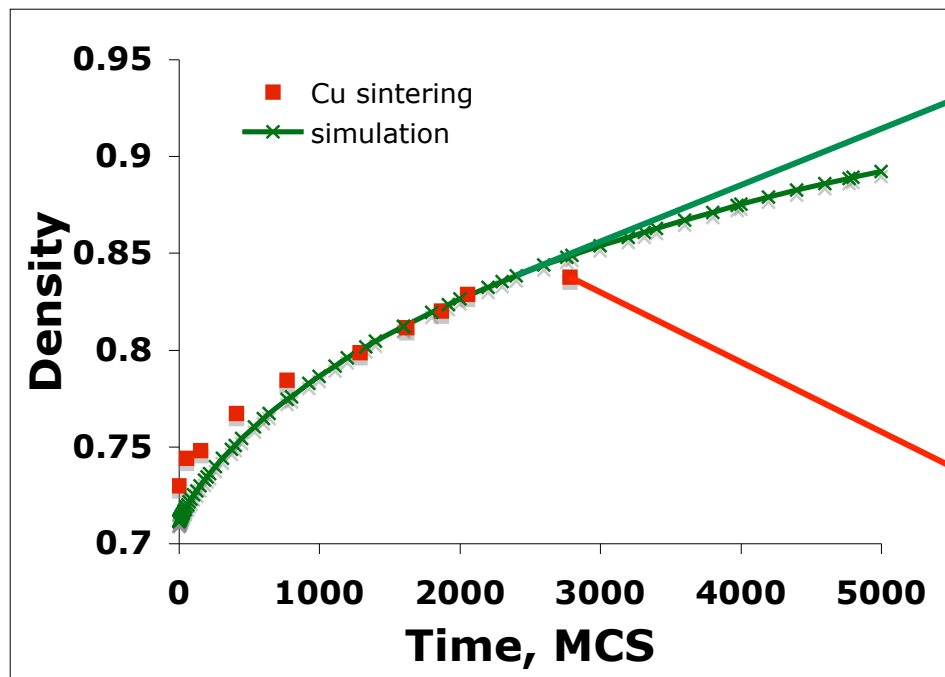


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Comparison of Potts Simulation and Cu-Experiments Microstructure & Densification



Comparison of Densification Microstructure & Densification



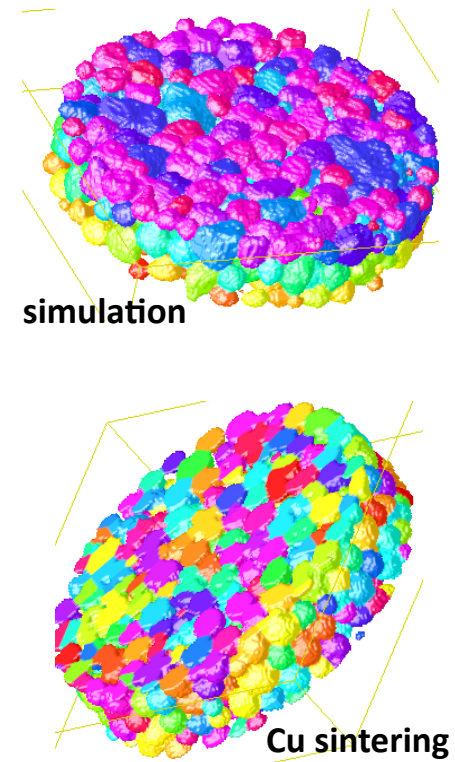
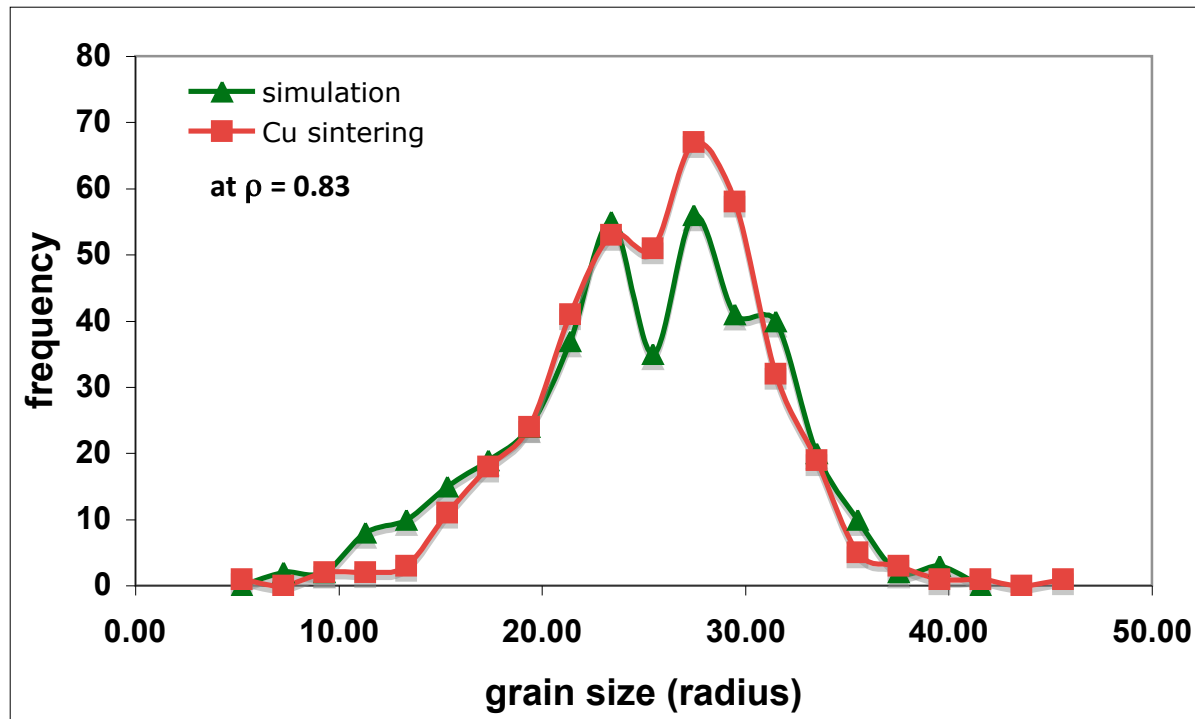
Very good agreement between the sintering simulation and Cu-sintering experiments.



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Comparison of Grain Size Distributions

- The overall GSD's have very similar sizes and distribution shape.
- There are 15 (out of 380) more grains in Cu sintering compacts because grains in the simulation are truncated at the edges.



The GSD from simulated sintering is very similar to the 3D image of Cu sintering. Differences are due primarily to edge effects.



Sintering Stress

- Driving force for sintering, ΔG , is the total change in free energy during sintering
 - Potts kMC model simulates the entire microstructural evolution
 - In response to grain boundary energy γ_{gb} and pore surface energy γ_s contributions

$$E = A_{gb}\gamma_{gb} + A_s\gamma_s$$

- Sintering stress, P_L , is the inherent sintering stress due to capillarity for densification.

- Energy Method
$$P_L = \frac{E_s(V_o + \Delta V) - E_s(V_o)}{\Delta V} = \frac{\partial E_s}{\partial V}$$

- Curvature Method
$$P_L = \gamma_s \bar{H} = \gamma_s \frac{\frac{1}{2} \iint_S \left(\frac{1}{r_1} + \frac{1}{r_2} \right) dS}{\iint_S dS}$$

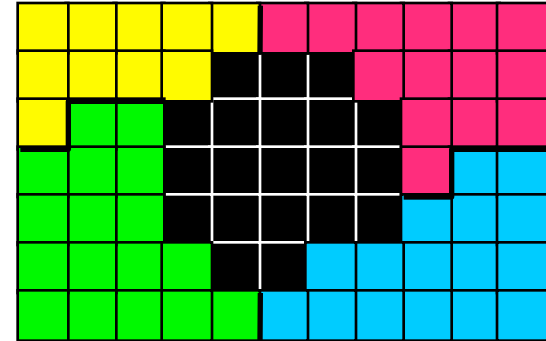


Sintering Stress

Measuring from Simulations

Energy Method

$$E = \frac{1}{2} \sum_{i=1}^P \sum_{j=1}^{26} J_s \left(1 - \delta(q_i, q_j) \right) \quad \text{For all pore sites } q_i$$



Curvature Method

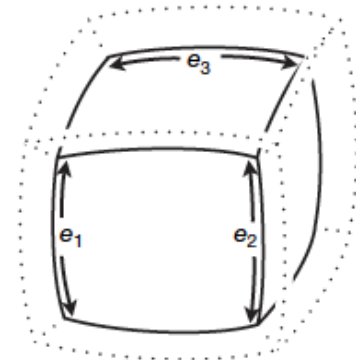
- For a polyhedron
 - Integral mean curvature

$$M_v = \underbrace{\iint_S \frac{1}{2} \left(\frac{1}{r_1} + \frac{1}{r_2} \right) dS}_{\text{Faces} = 0} + \underbrace{\frac{1}{2\pi} \sum_{e=1}^E l_e \beta_e}_{\text{Edges}}$$

- Digitized microstructure

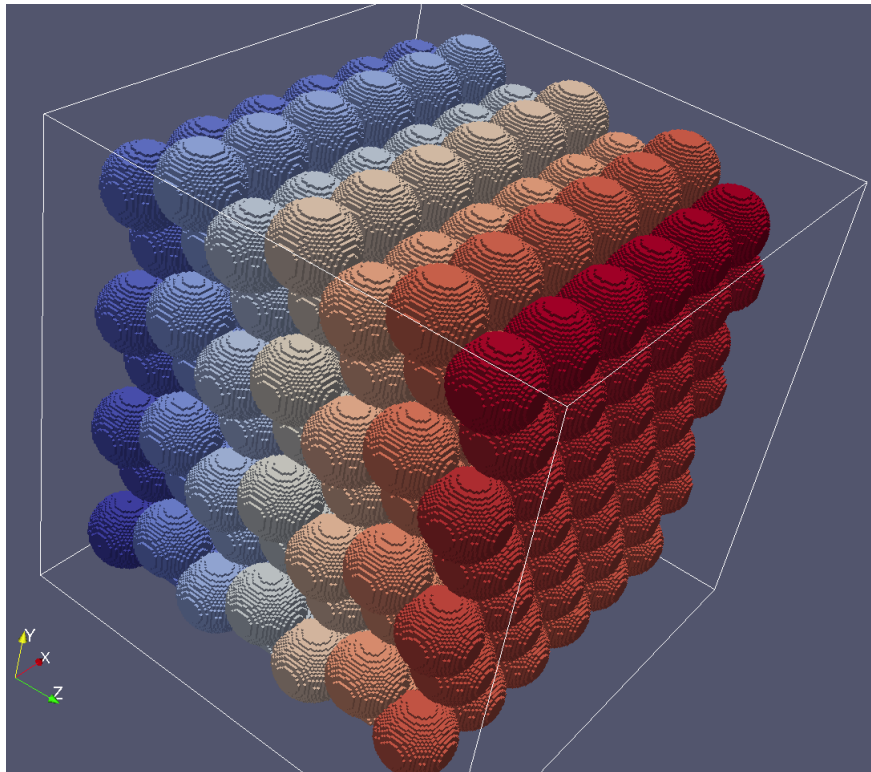
Faces = 0

Edges



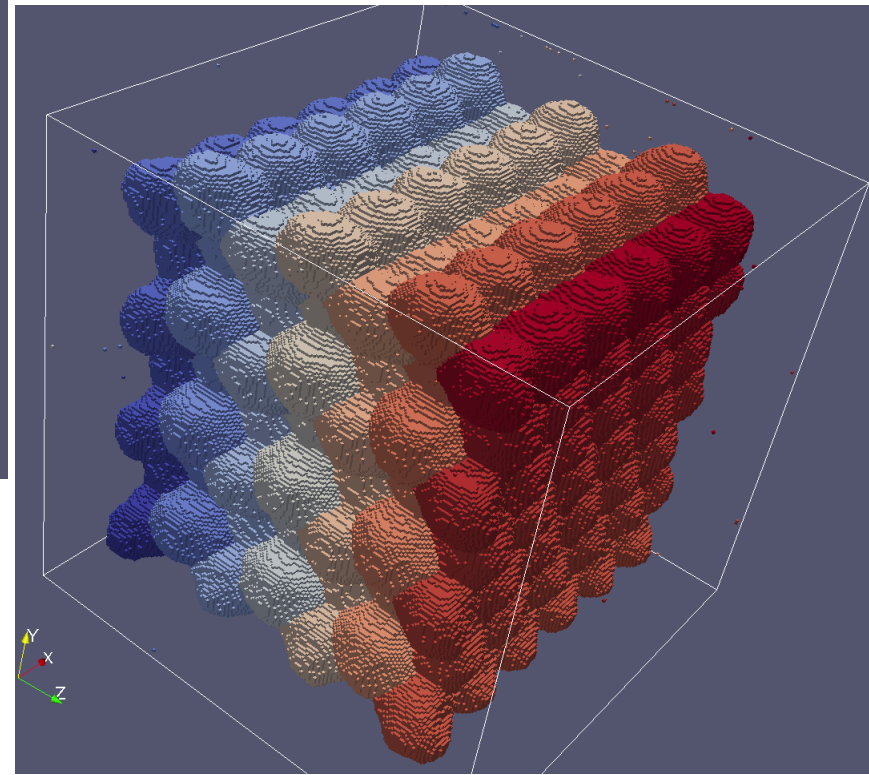
Potts kMC Model

Simulation of Close-Packed Spheres Sintering



Density = 72% at $t = 0$ MCS

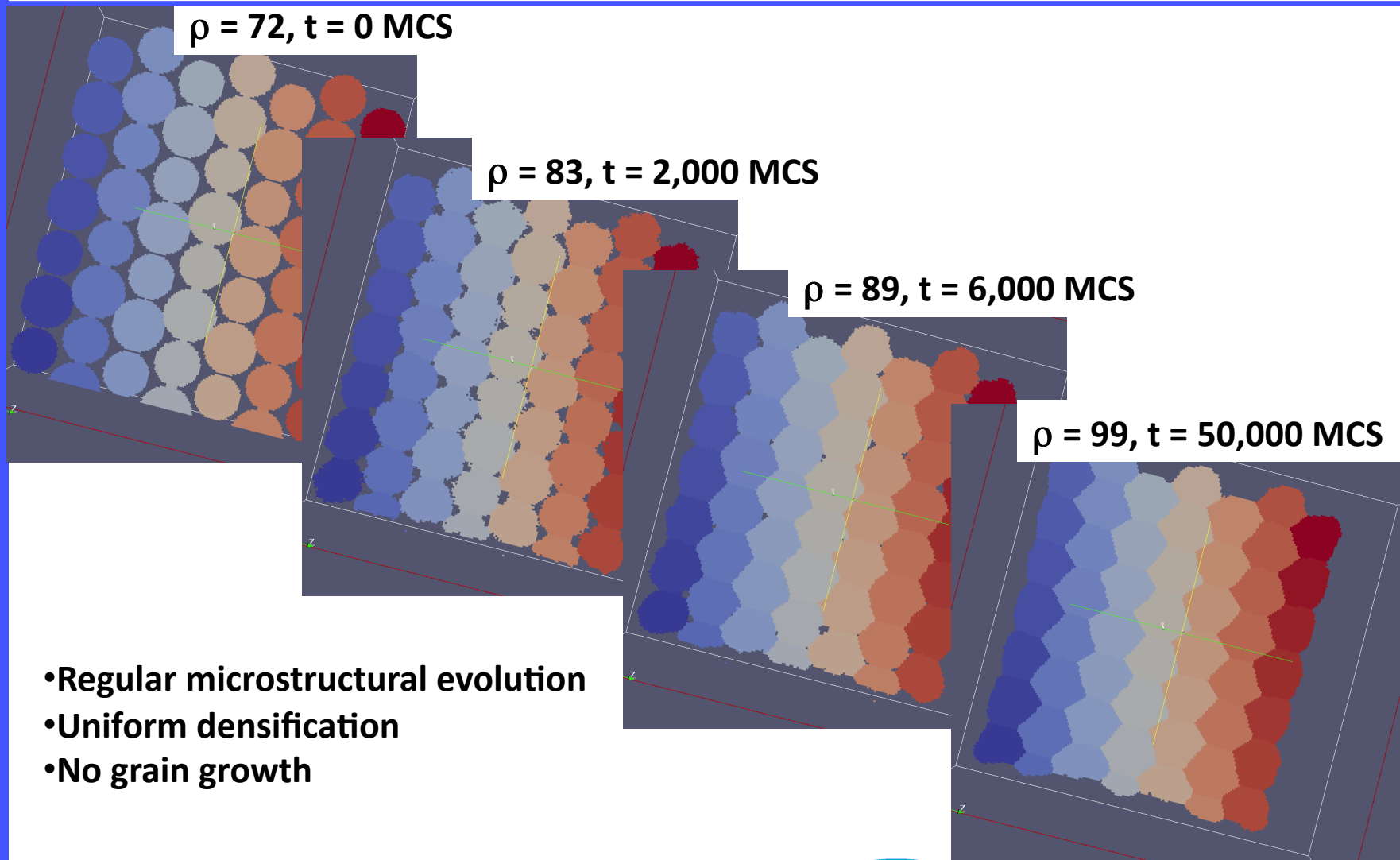
Density = 100% at $t = 60,000$ MCS



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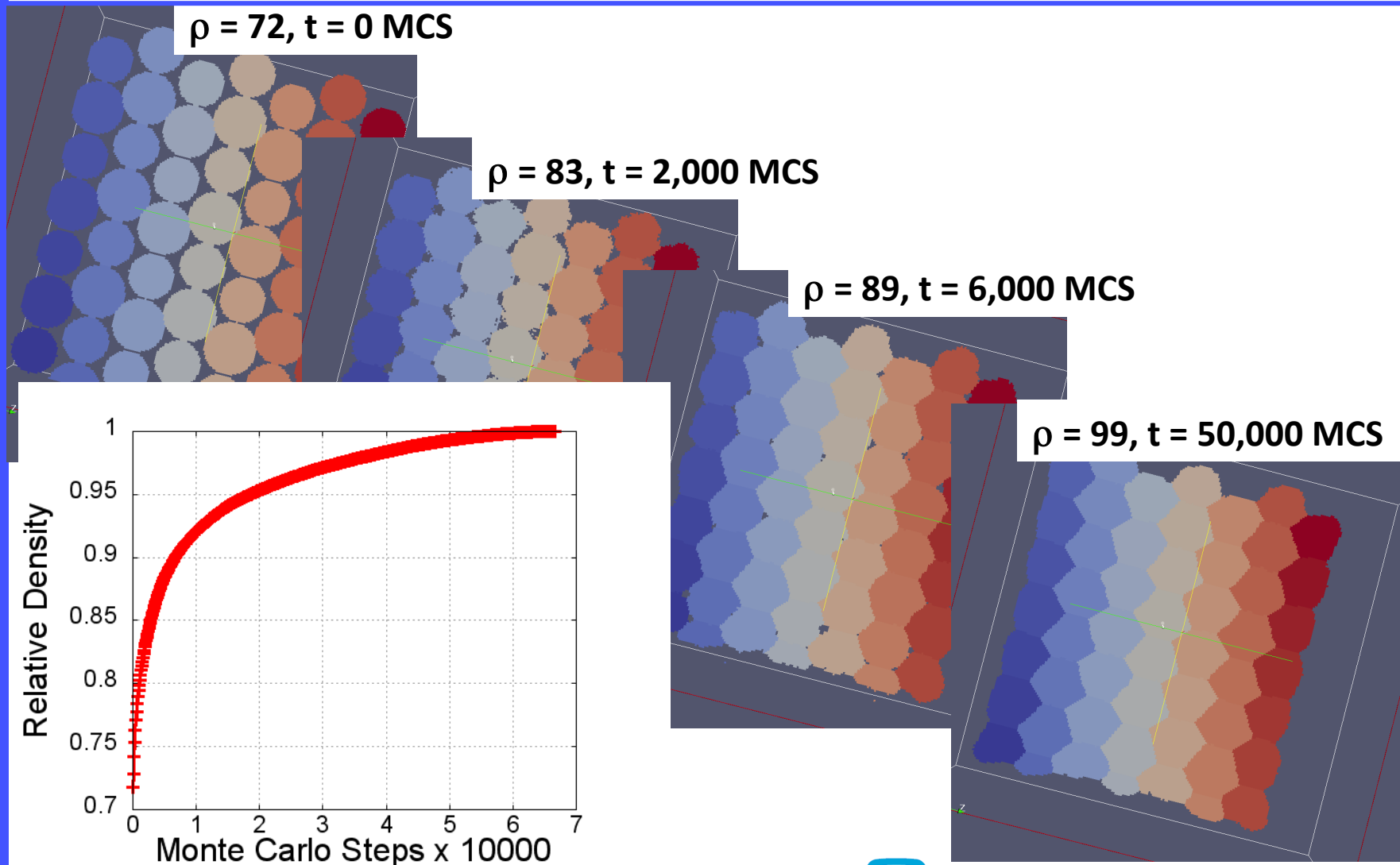
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Simulation of Close-Packed Spheres Sintering



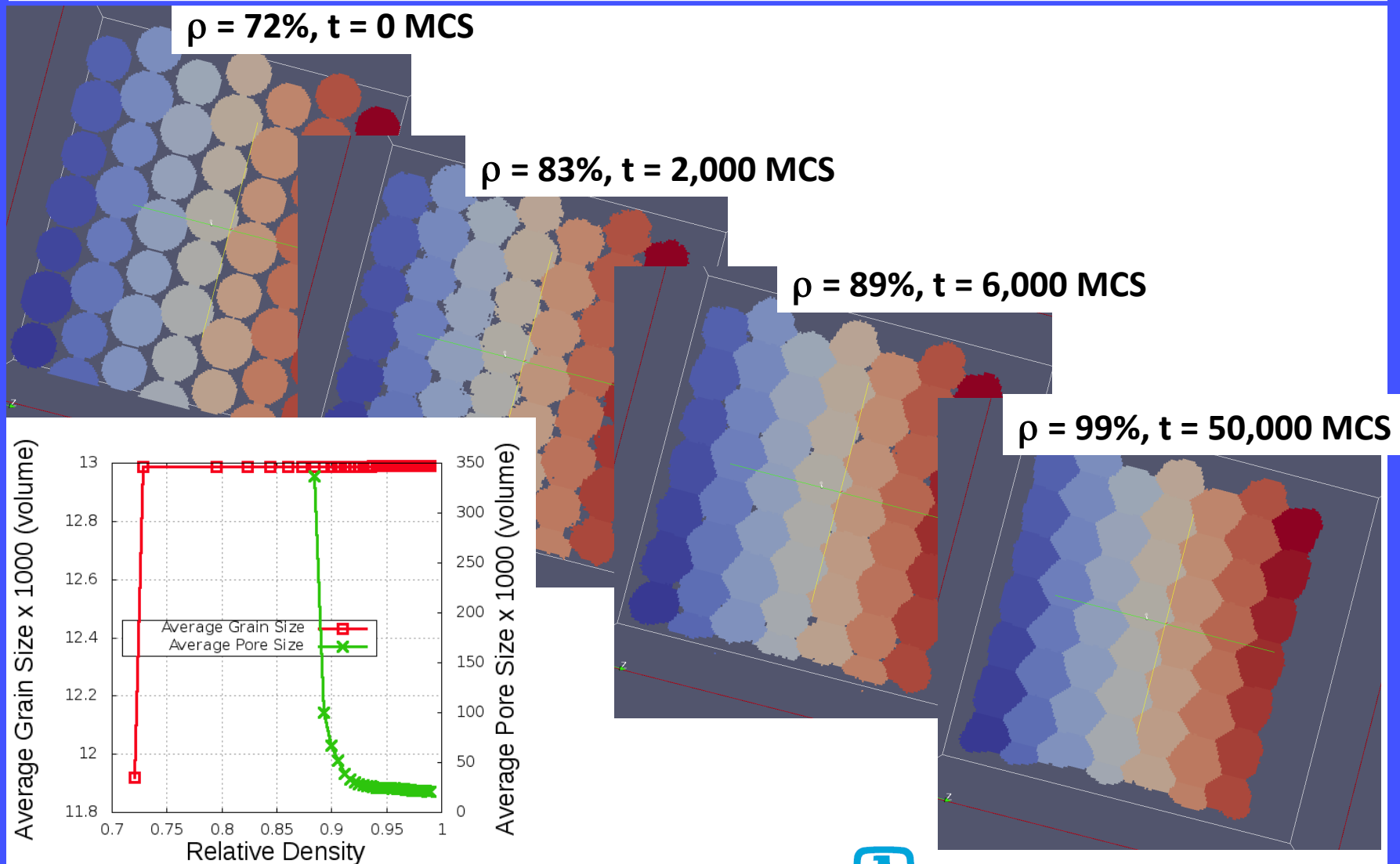
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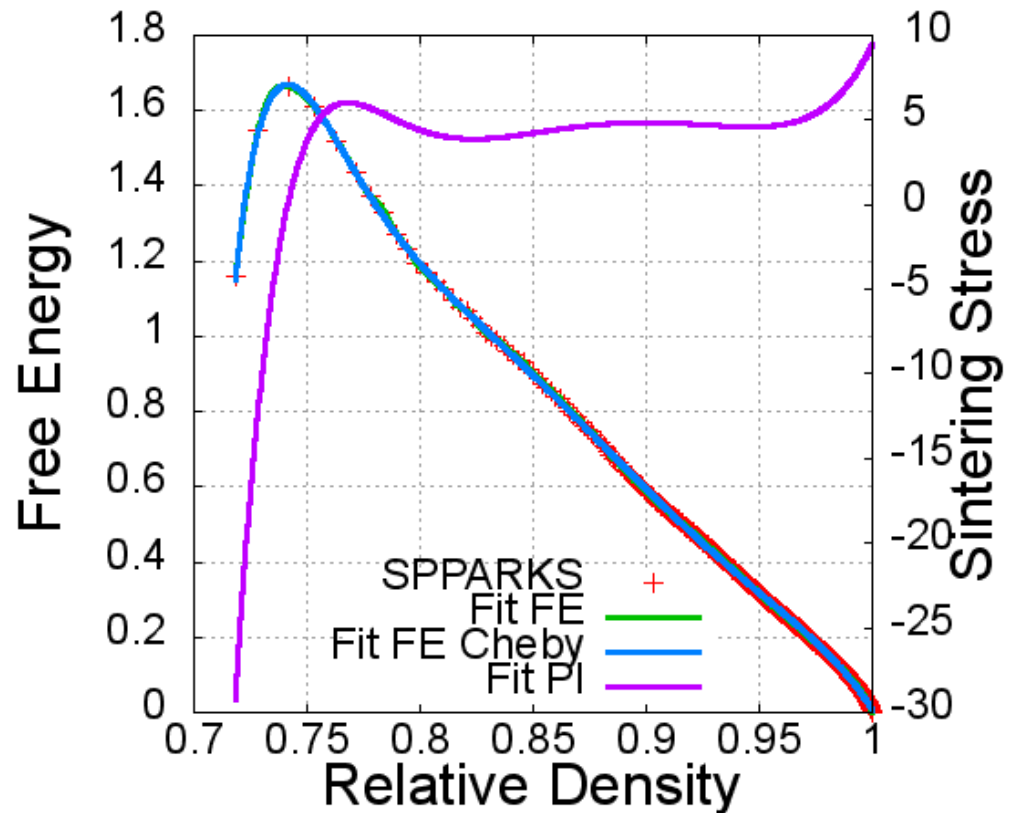
Simulation of Close-Packed Spheres Sintering



Sintering Stress, Energy Method

Simulation of Close-Packed Spheres Sintering

- Energy method $P_L = \frac{\partial E_s}{\partial V}$
- Data from simulations is $E_s(\rho)$
- Fit $E_s(\rho)$ with **splines**, results in noisy P_L
- Fit $E_s(\rho)$ with **Chebyshev poly**
- Resulting P_L
- P_L is initially negative due to initial pore curvature.
- Becomes ~constant and then increases at pores become isolated and small.



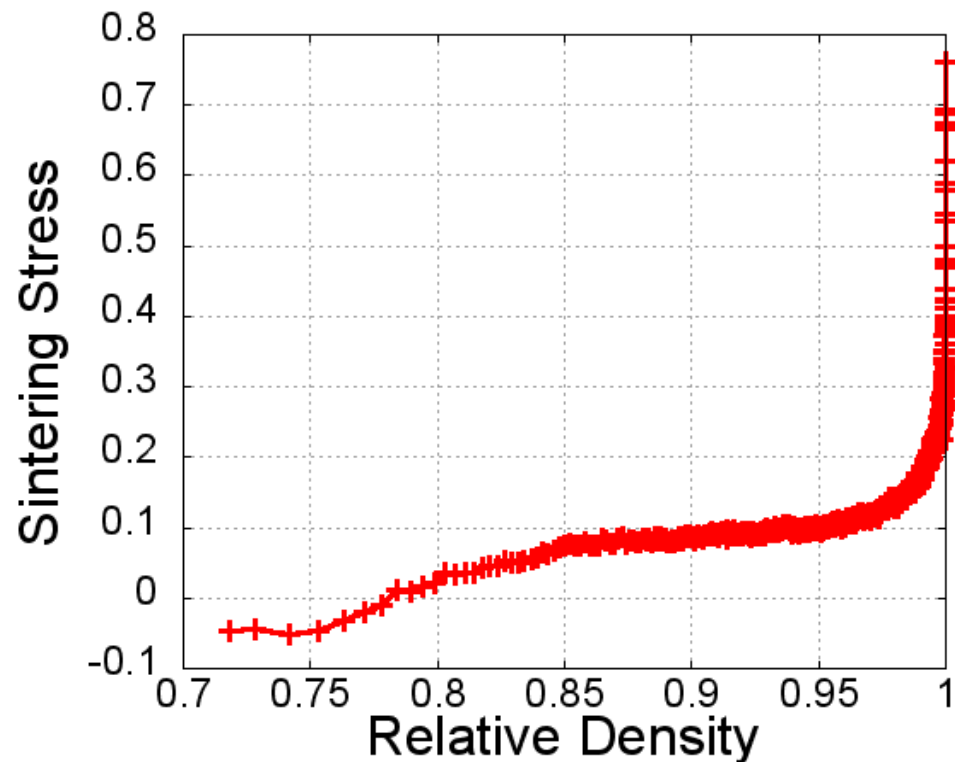
While overall trend is accurate, P_L is sensitive to the fitting technique used with the energy method



Sintering Stress, Curvature Method

Simulation of Close-Packed Spheres Sintering

- Curvature method $P_L = \gamma_s \bar{H} = \gamma_s \frac{M_v}{S_v}$
- Directly measure from the simulated microstructures
- Is an instantaneous measure and does not depend on the microstructural evolution path
- P_L initially negative
- P_L increase with increasing pore curvature.

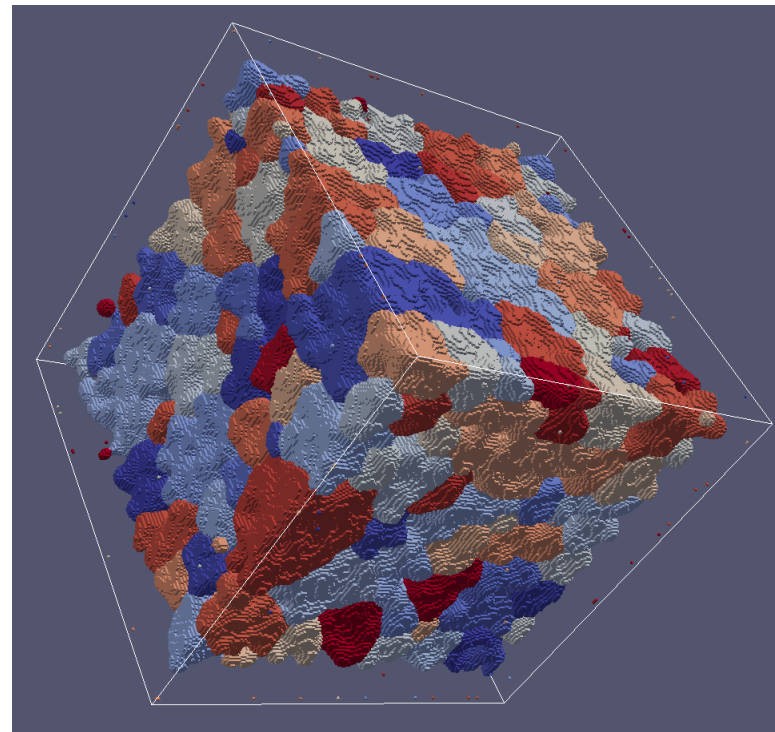
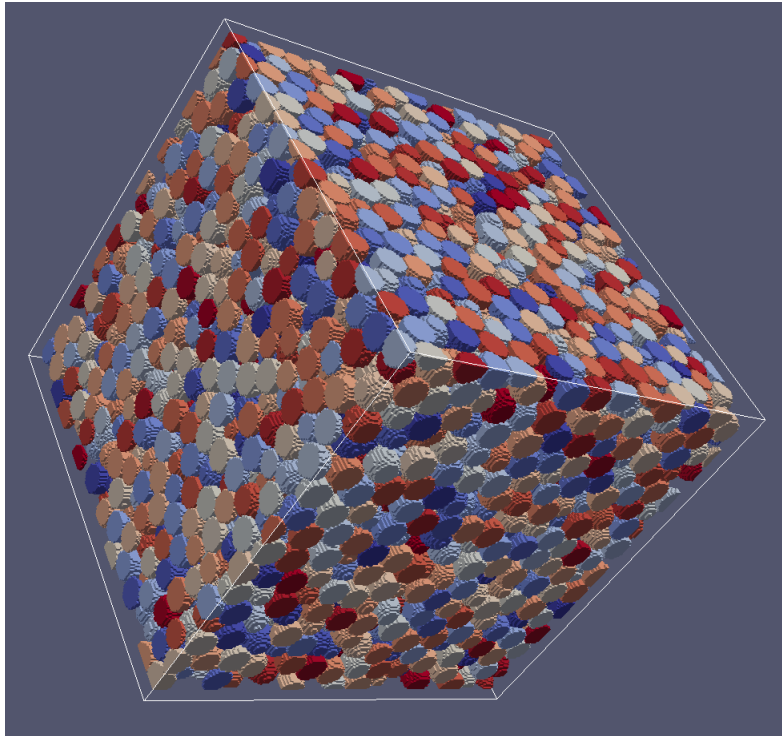


Curvature method will be used for the remainder of this work



Potts kMC Model

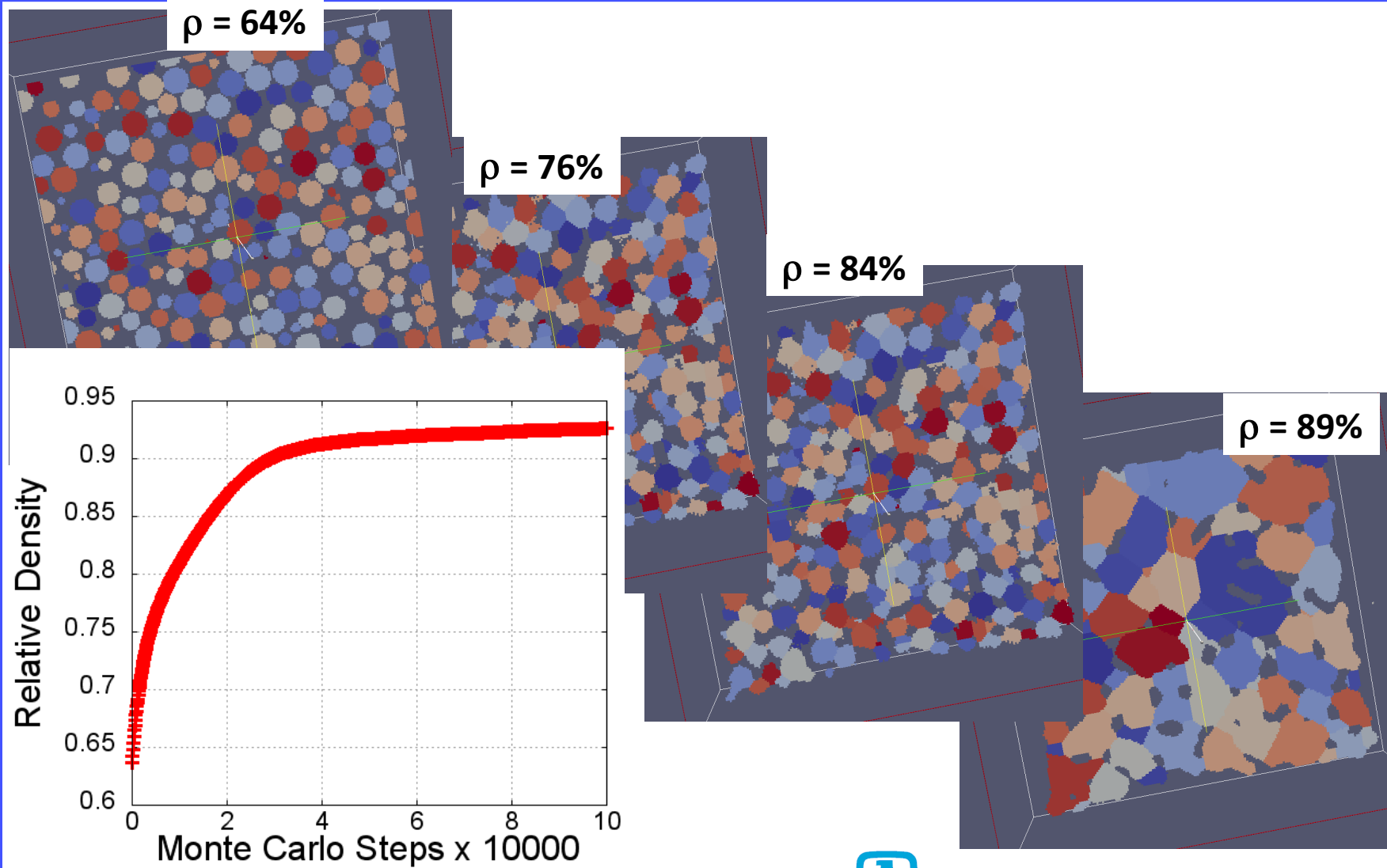
Simulation of Randomly-Packed Mono-Sized Spheres Sintering



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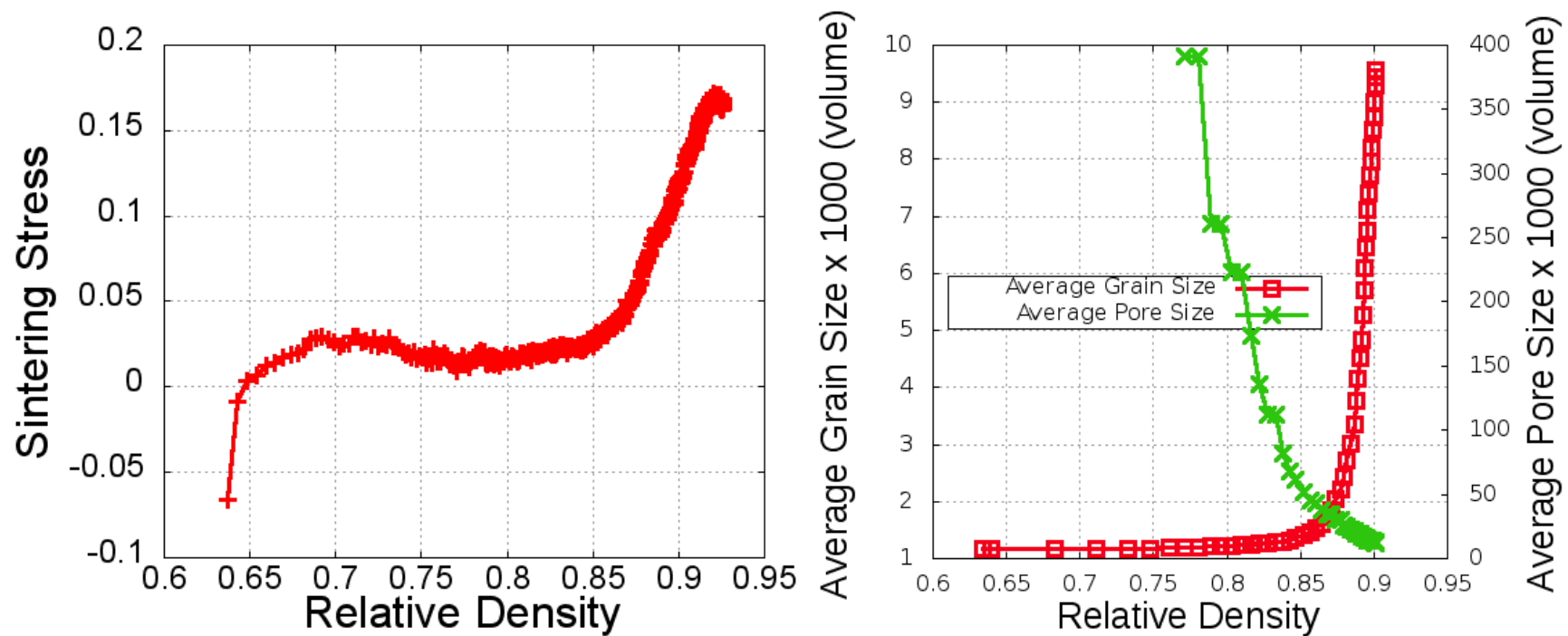
Potts kMC Model

Simulation of Randomly-Packed Mono-Sized Spheres Sintering



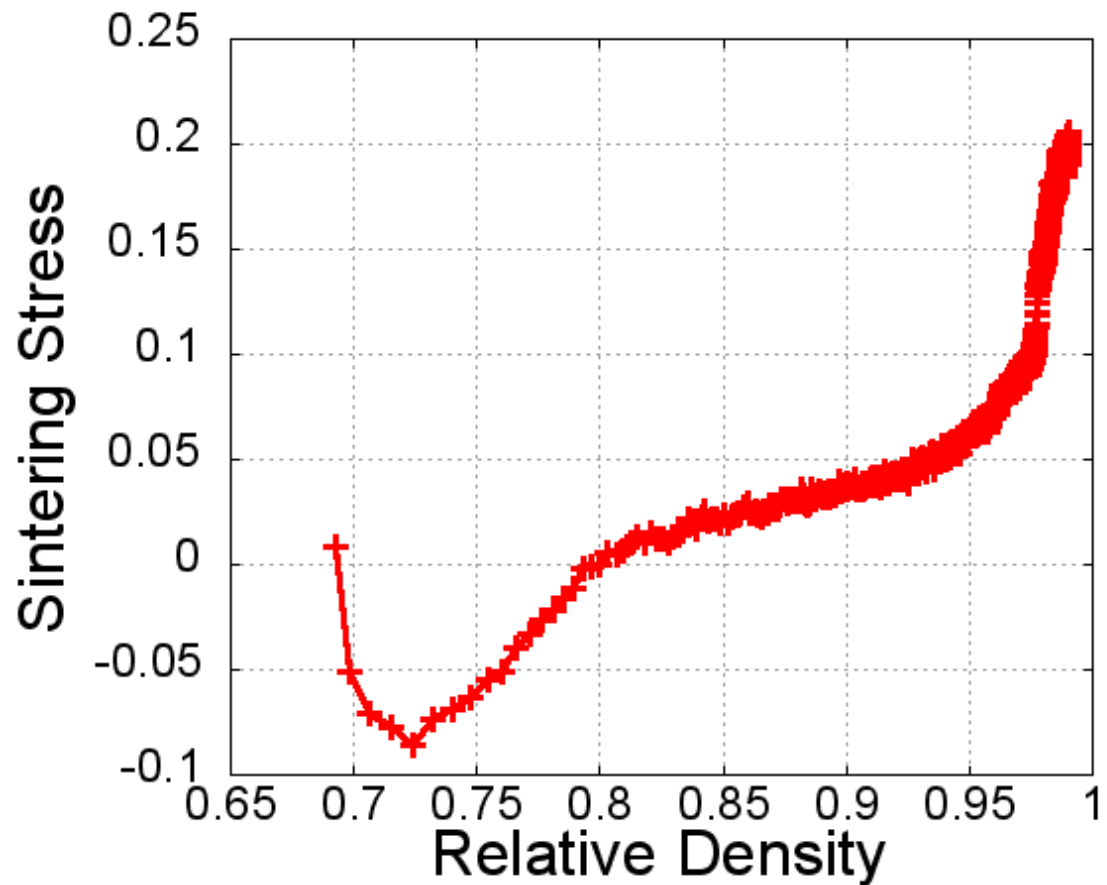
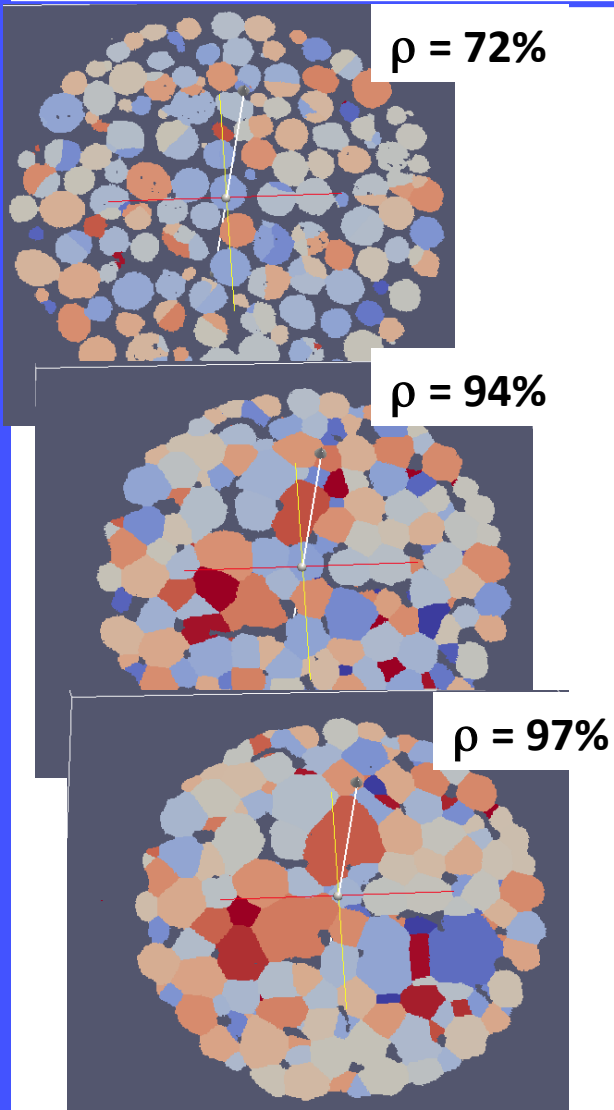
Sintering Stress

Simulation of Randomly-Packed Mono-Sized Spheres Sintering



Sintering Stress

Simulation of Cu-Particle Compact Sintering

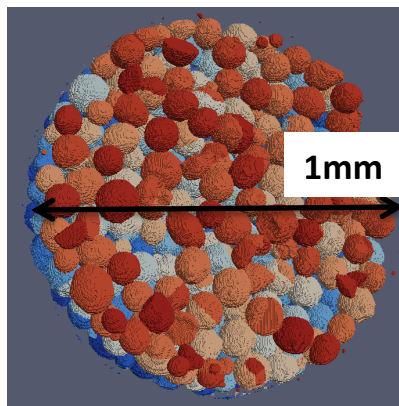


Sintering Stress

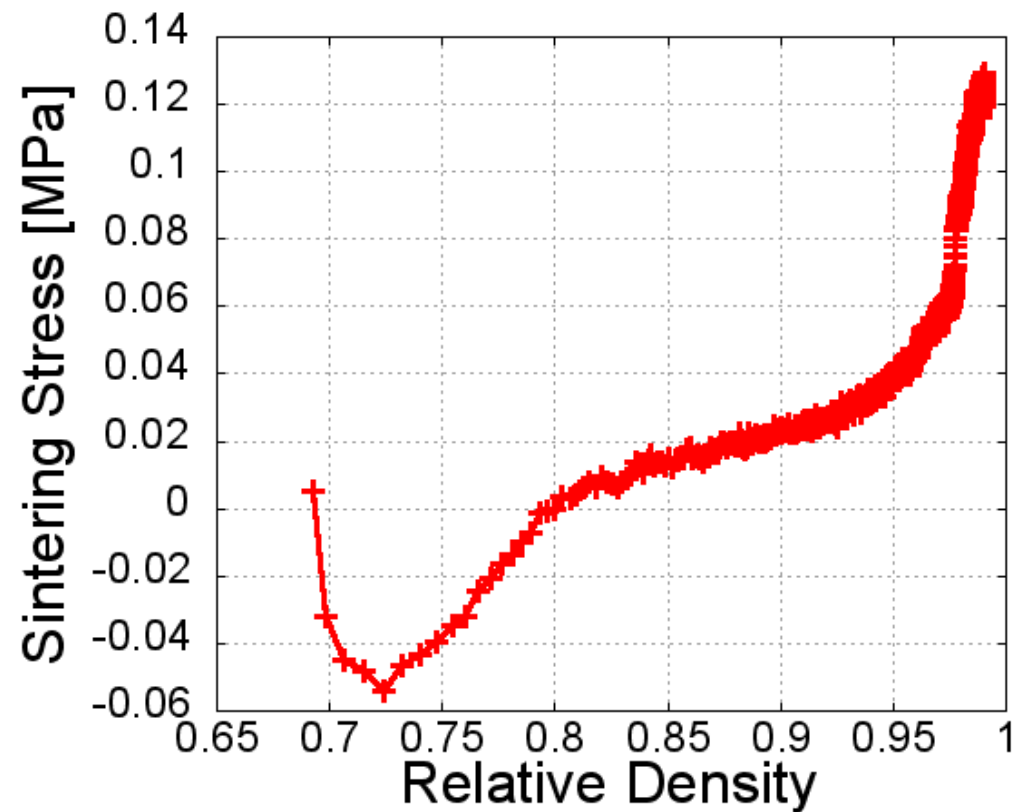
Simulation of Cu-Particle Compact Sintering

Obtaining P_L with units for real systems

- units of spatial dimension



- Assume $\gamma_s = 1 \text{ J/m}^2$ at 1050°C



Summary and Conclusions

- **A model that is capable of simulating simple, solid-state sintering has been presented.**
 - True mesoscale with hundred or thousands of particles
 - Arbitrarily complex powder particles of different geometries
- **It can incorporate all the mechanisms necessary for simulation of microstructural evolution during sintering**
 - Generation, diffusion and annihilations of vacancies
 - Surface diffusion at pore surface
 - Curvature-driven grain growth
- **Has sufficient detail to characterize detailed topological and kinetic characteristics**
- **Can be extended to include more mechanisms and vary thermodynamics and kinetic characteristics.**

